KEMET Part Number: C0805C829C2GACTU

(C0805C829C2GAC7800)



SMD Comm C0G, Ceramic, 8.2 pF, +/-0.25 pF, 200 VDC, C0G, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0805



| Supplier: | KEMET |
|--------------|---|
| Series: | SMD Comm C0G |
| Style: | SMD Chip |
| Description: | SMD, MLCC, Ultra-Stable, Low Loss, Class I |
| Features: | Ultra-Stable, Low Loss, Class I |
| RoHS: | Yes |
| Termination: | Tin |
| Marking: | No |
| Chip Size: | 0805 |

General Information

| Dimensions | |
|------------|------------------|
| L | 2mm +/-0.2mm |
| W | 1.25mm +/-0.2mm |
| Т | 0.78mm +/-0.10mm |
| S | 0.75mm MIN |
| В | 0.5mm +/-0.25mm |

| Packaging Specifications | |
|--------------------------|------------------------|
| Packaging: | T&R, 180mm, Paper Tape |
| Packaging Quantity: | 4000 |

| Specifications | |
|-------------------------------------|---------------------|
| Capacitance: | 8.2 pF |
| Capacitance Tolerance: | +/-0.25 pF |
| Voltage DC: | 200 VDC |
| Dielectric Withstanding Voltage: | 500 V |
| Temperature Range: | -55/+125C |
| Temperature Coefficient: | COG |
| Dissipation Factor: | 0.10% 1MHz 25C |
| Aging Rate: | 0% Loss/Decade Hour |
| Insulation Resistance: | 100 GOhms |

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